

## FSTU6800

### 10-Bit Bus Switch with Precharged Outputs and -2V Undershoot Protection

#### General Description

The Fairchild Switch FSTU6800 provides 10-bits of high-speed CMOS TTL-compatible bus switching. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. Both the A Ports and the B Ports have "undershoot hardened" circuit protection to support an extended input range to 2.0V below ground. Fairchild's integrated Undershoot Hardened Circuit (UHC®) senses undershoot at the I/Os, and responds by preventing voltage differentials from developing and turning on the switch. The device also precharges the B Port to a selectable bias voltage (BiasV) to minimize live insertion noise.

The device is organized as a 10-bit switch with a bus enable ( $\overline{OE}$ ) signal. When  $\overline{OE}$  is LOW, the switch is ON and Port A is connected to Port B. When  $\overline{OE}$  is HIGH, the switch is OPEN and the B Port is precharged to BiasV through an equivalent 10-k $\Omega$  resistor.

#### Features

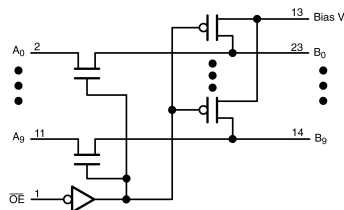
- 4 $\Omega$  switch connection between two ports.
- Undershoot Hardened to -2.0V.
- Soft enable turn-on to minimize bus-to-bus charge sharing during enable.
- Low  $I_{CC}$ .
- Zero bounce in flow-through mode.
- Output precharge to minimize live insertion noise.
- Control inputs compatible with TTL level.
- See Applications Note AN-5008 for details.

#### Ordering Code:

Order Number	Package Number	Package Description
FSTU6800WM	M24B	24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
FSTU6800QSC	MQA24	24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide
FSTU6800MTC	MTC24	24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

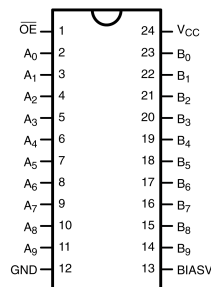
#### Logic Diagram



#### Pin Descriptions

Pin Name	Description
$\overline{OE}$	Bus Switch Enable
A	Bus A
B	Bus B
BiasV	Bus B Voltage Bias

#### Connection Diagram



#### Truth Table

$\overline{OE}$	$B_0-B_9$	Function
L	$A_0-A_9$	Connect
H	BiasV	Precharge

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**Absolute Maximum Ratings** (Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Switch Voltage ( $V_S$ )	-2.0V to +7.0V
Bias V Voltage Range	-0.5V to +7.0V
DC Input Voltage ( $V_{IN}$ ) (Note 2)	-0.5V to +7.0V
DC Input Diode Current ( $I_{IK}$ ) $V_{IN} < 0V$	-50mA
DC Output ( $I_{OUT}$ ) Sink Current	128mA
DC $V_{CC}/GND$ Current ( $I_{CC}/I_{GND}$ )	+/- 100mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150 °C

**Recommended Operating Conditions** (Note 3)

Power Supply Operating ( $V_{CC}$ )	4.0V to 5.5V
Precharge Supply (BiasV)	1.5V to $V_{CC}$
Input Voltage ( $V_{IN}$ )	0V to 5.5V
Output Voltage ( $V_{OUT}$ )	0V to 5.5V
Input Rise and Fall Time ( $t_r, t_f$ )	
Switch Control Input	0 nS/V to 5 nS/V
Switch I/O	0nS/V to DC
Free Air Operating Temperature ( $T_A$ )	-40 °C to +85 °C

**Note 1:** The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The Recommended Operating Conditions tables will define the conditions for actual device operation.

**Note 2:** The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

**Note 3:** Unused control inputs must be held HIGH or LOW. They may not float.

**DC Electrical Characteristics**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = -40\text{ }^\circ\text{C to }+85\text{ }^\circ\text{C}$			Units	Conditions
			Min	Typ (Note 5)	Max		
$V_{IK}$	Clamp Diode Voltage	4.5			-1.2	V	$I_{IN} = -18\text{mA}$
$V_{IH}$	HIGH Level Input Voltage	4.0-5.5	2.0			V	
$V_{IL}$	LOW Level Input Voltage	4.0-5.5			0.8	V	
$I_I$	Input Leakage Current	5.5			$\pm 1.0$	$\mu\text{A}$	$0 \leq V_{IN} \leq 5.5\text{V}$
$I_O$	Output Current	4.5	0.25			mA	BiasV = 2.4V, B = 0
$I_{OZ}$	OFF-STATE Leakage Current	5.5			$\pm 1.0$	$\mu\text{A}$	$0 \leq A \leq V_{CC}, V_{IN} = V_{IH}$
$R_{ON}$	Switch On Resistance (Note 4)	4.5		4	7	$\Omega$	$V_S = 0\text{V}, I_{IN} = 64\text{mA}$
		4.5		4	7	$\Omega$	$V_S = 0\text{V}, I_{IN} = 30\text{mA}$
		4.5		8	15	$\Omega$	$V_S = 2.4\text{V}, I_{IN} = 15\text{mA}$
		4.0		11	20	$\Omega$	$V_S = 2.4\text{V}, I_{IN} = 15\text{mA}$
$I_{CC}$	Quiescent Supply Current	5.5			3	$\mu\text{A}$	$V_S = V_{CC}$ or GND, $I_{OUT} = 0$
$\Delta I_{CC}$	Increase in $I_{CC}$ per Input	5.5			2.5	mA	$\overline{OE}$ input at 3.4V Other inputs at $V_{CC}$ or GND
$I_{BIAS}$	Bias Pin Leakage Current	5.5			$\pm 1.0$	$\mu\text{A}$	$\overline{OE} = 0\text{V}, B = 0\text{V}, \text{BiasV} = 5.5\text{V}$
$I_{OZU}$	Switch Undershoot Current	5.5			100	$\mu\text{A}$	$I_{IN} = -20\text{mA}, \overline{OE} = 5.5\text{V}, V_{OUT} \geq V_{IH}$
$V_{IKU}$	Voltage Undershoot	5.5			-2.0	V	$0.0\text{mA} \geq I_{IN} \geq -50\text{mA}, \overline{OE} = 5.5\text{V}$

**Note 4:** Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

**Note 5:** Typical values are at  $V_{CC} = 5.0\text{V}$  and  $T_A = +25^\circ\text{C}$

## AC Electrical Characteristics

Symbol	Parameter	$T_A = -40\text{ }^\circ\text{C to } +85\text{ }^\circ\text{C},$ $C_L = 50\text{ pF}, RU = RD = 500\Omega$				Units	Conditions	Figure No.
		$V_{CC} = 4.5 - 5.5\text{V}$		$V_{CC} = 4.0\text{V}$				
		Min	Max	Min	Max			
$t_{PHL}, t_{PLH}$	Prop Delay Bus to Bus (Note 6)		0.25		0.25	ns	$V_I = \text{OPEN}$	Figures 1, 2
$t_{PZH}$	Output Enable Time	7.0	30.0		35.0	ns	$V_I = \text{OPEN}$ $\text{Bias} V = \text{GND}$	Figures 1, 2
$t_{PZL}$		7.0	30.0		35.0	ns	$V_I = 7\text{V}$ $\text{Bias} V = 3\text{V}$	
$t_{PHZ}$	Output Disable Time	1.0	6.1		6.5	ns	$V_I = \text{OPEN}$ $\text{Bias} V = \text{GND}$	Figures 1, 2
$t_{PLZ}$		1.0	7.3		6.8	ns	$V_I = 7\text{V}$ $\text{Bias} V = 3\text{V}$	

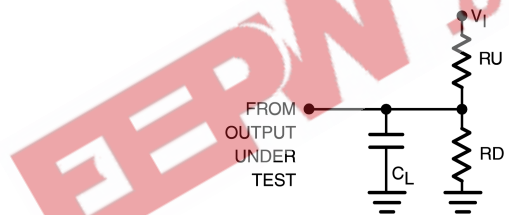
**Note 6:** This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage the source (zero output impedance).

### Capacitance (Note 7)

Symbol	Parameter	Typ	Max	Units	Conditions
$C_{IN}$	Control Pin Input Capacitance	3		pF	$V_{CC} = 5.0\text{V}$
$C_{I/O}$	Input/Output Capacitance	5		pF	$V_{CC}, \text{OE} = 5.0\text{V}$

**Note 7:**  $T_A = +25\text{ }^\circ\text{C}, f = 1\text{ MHz}$ , Capacitance is characterized but not tested.

### AC Loading and Waveforms

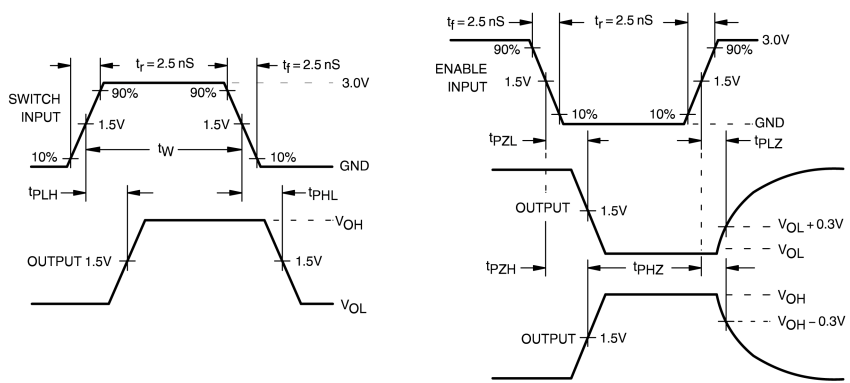


**Note:** Input driven by 50  $\Omega$  source terminated in 50  $\Omega$ ,  $RU = RD = 500\ \Omega$

**Note:**  $C_L$  includes load and stray capacitance,  $C_L = 50\text{ pF}$

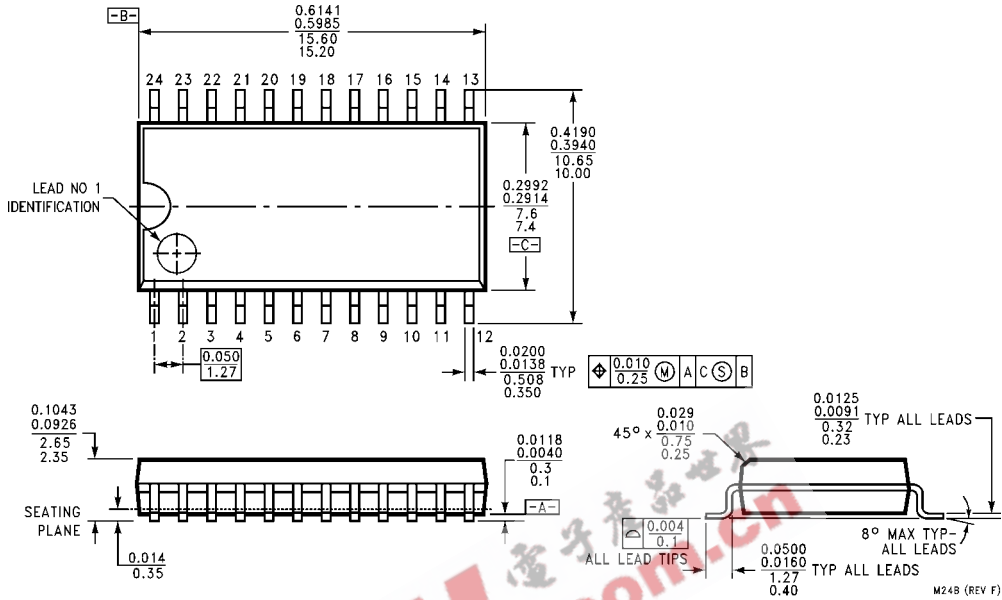
**Note:** Input PRR = 1.0 MHz,  $t_W = 500\text{ ns}$

**FIGURE 1. AC Test Circuit**

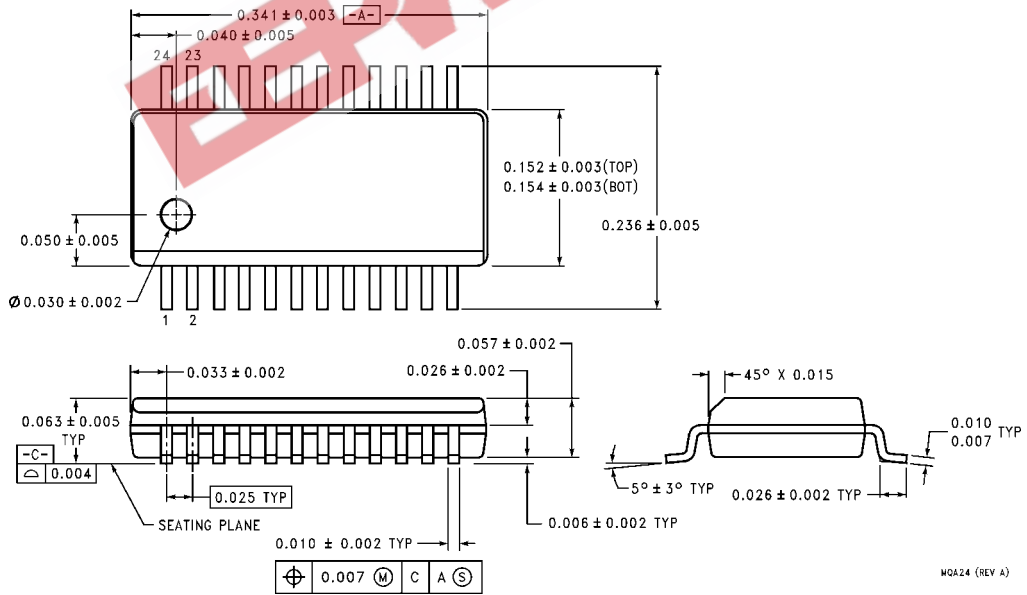


**FIGURE 2. AC Waveforms**

**Physical Dimensions** inches (millimeters) unless otherwise noted

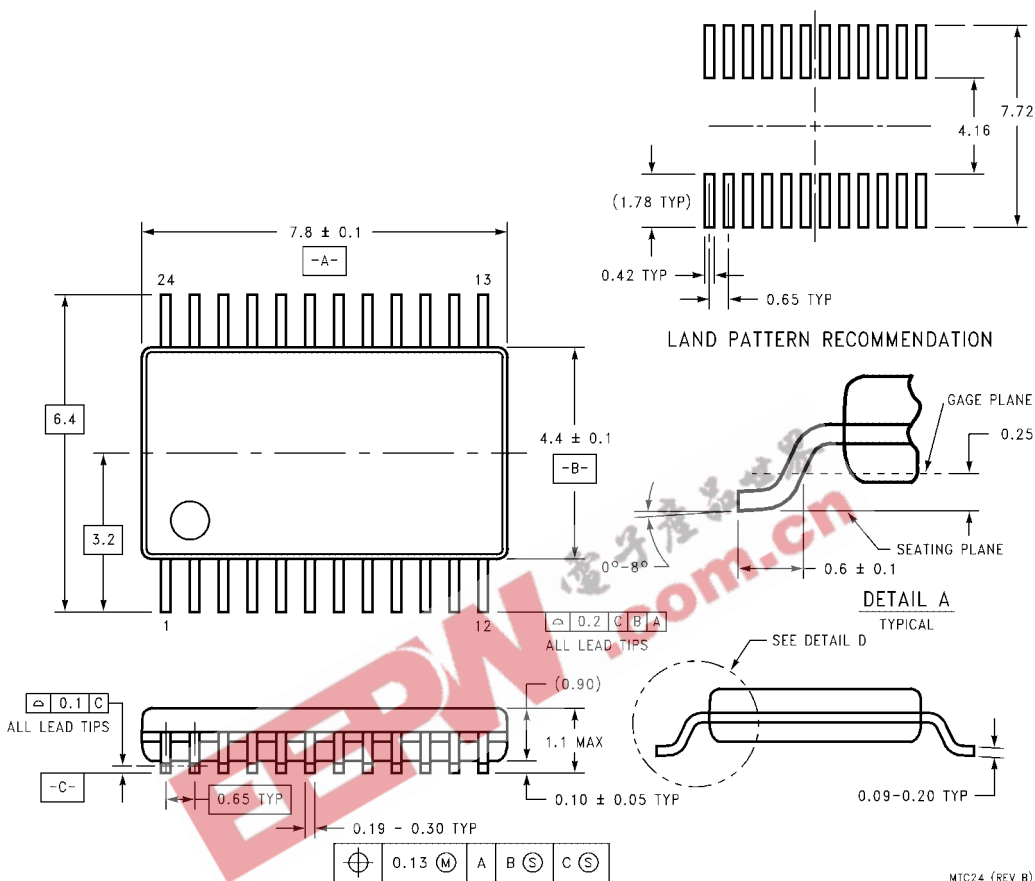


**24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide Package Number M24B**



**24-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide Package Number MQA24**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide  
Package Number MTC24**

**Technology Description**

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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